Final datasheet

EconoDUAL™3 module with Trench/Fieldstop IGBT4 and emitter controlled 3 diode

Features

- Electrical features
  - V_{CES} = 1700 V
  - $I_{C\ nom}$ = 250 A / I_{CRM} = 500 A
  - $V_{CE,sat}$ with positive temperature coefficient
  - Trench IGBT 4
  - Low $V_{CE,sat}$
  - High short-circuit capability
  - High DC stability
  - $T_{vj,op}$ = 150°C
- Mechanical features
  - Al_2O_3 substrate with low thermal resistance
  - High power density
  - Isolated base plate
  - PressFIT contact technology

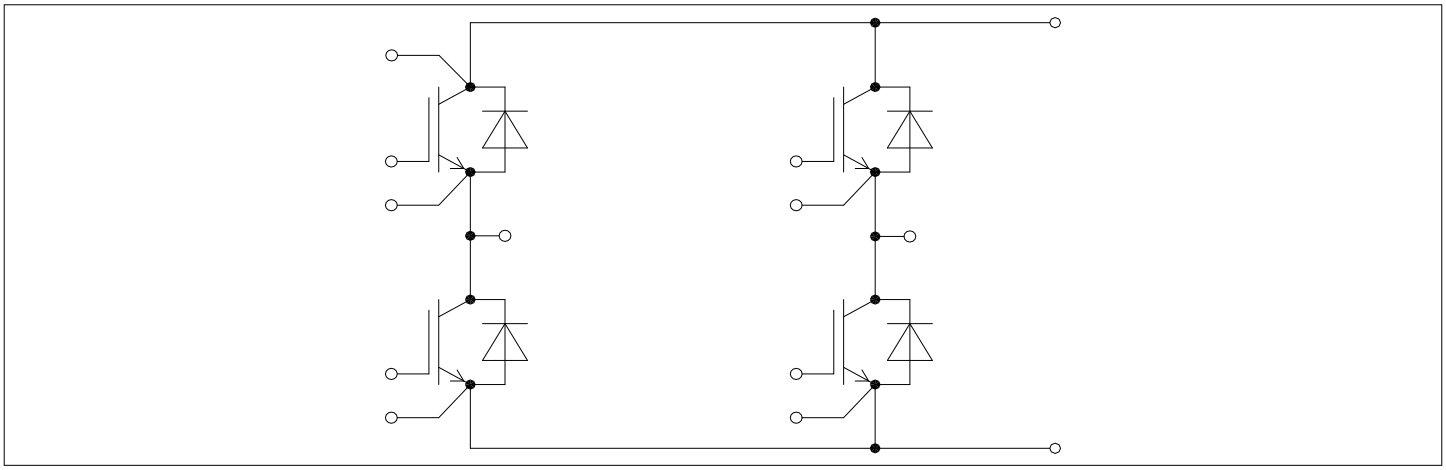
Potential applications

- Wind turbines
- Medium-voltage converters
- High-power converters

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description



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1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, f = 50 Hz, *t* = 1 min	3.4	kV
Material of module baseplate			Cu	
Internal isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Creepage distance	$d_{Creep\ nom}$	terminal to baseplate, nom., (PD2, IEC 60664-1, Ed. 3.0)	> 15	mm
Creepage distance	$d_{Creep\ min}$	terminal to baseplate, min., (PD2, IEC 60664-1, Ed. 3.0)	14.7	mm
Creepage distance	$d_{Creep\ nom}$	terminal to terminal, nom., (PD2, IEC 60664-1, Ed. 3.0)	12.1	mm
Creepage distance	$d_{Creep\ min}$	terminal to terminal, min., (PD2, IEC 60664-1, Ed. 3.0)	11.5	mm
Clearance	$d_{Clear\ nom}$	terminal to baseplate, nom.	> 12.5	mm
Clearance	$d_{Clear\ min}$	terminal to baseplate, min.	12.5	mm
Clearance	$d_{Clear\ nom}$	terminal to terminal, nom.	10.0	mm
Clearance	$d_{Clear\ min}$	terminal to terminal, min.	9.6	mm
Comparative tracking index	*CTI*		> 200	
Relative thermal index (electrical)	*RTI*	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Stray inductance module	L_{sCE}				26		nH
Storage temperature	T_{stg}			-40		125	°C
Mounting torque for module mounting	*M*	- Mounting according to valid application note	M5, Screw	3		6	Nm
Terminal connection torque	*M*	- Mounting according to valid application note	M6, Screw	3		6	Nm
Weight	*G*				345		g

***Note**: The labels AC and DC on the housing do not have relevance.*

2 IGBT, Inverter

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CES}		T_{vj} = 25 °C	1700	V
Continuous DC collector current	I_{CDC}	$T_{vj\,max}$ = 175 °C	T_C = 100 °C	250	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj\,op}$		500	A
Gate-emitter peak voltage	V_{GES}			±20	V

Table 4 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\,sat}$	I_C = 250 A, V_{GE} = 15 V	T_{vj} = 25 °C		1.80	2.30	V
			T_{vj} = 125 °C		2.15		
			T_{vj} = 150 °C		2.30		
Gate threshold voltage	V_{GEth}	I_C = 9.4 mA, V_{CE} = V_{GE}, T_{vj} = 25 °C		5.20	5.80	6.40	V
Gate charge	Q_G	V_{GE} = ±15 V			2.25		µC
Internal gate resistor	R_{Gint}	T_{vj} = 25 °C			5.8		Ω
Input capacitance	C_{ies}	f = 1000 kHz, T_{vj} = 25 °C, V_{CE} = 25 V, V_{GE} = 0 V			21		nF
Reverse transfer capacitance	C_{res}	f = 1000 kHz, T_{vj} = 25 °C, V_{CE} = 25 V, V_{GE} = 0 V			0.68		nF
Collector-emitter cut-off current	I_{CES}	V_{CE} = 1700 V, V_{GE} = 0 V	T_{vj} = 25 °C			3	mA
Gate-emitter leakage current	I_{GES}	V_{CE} = 0 V, V_{GE} = 20 V, T_{vj} = 25 °C				400	nA
Turn-on delay time (inductive load)	t_{don}	I_C = 250 A, V_{CC} = 900 V, V_{GE} = ±15 V, R_{Gon} = 1 Ω	T_{vj} = 25 °C		0.360		µs
			T_{vj} = 125 °C		0.400		
			T_{vj} = 150 °C		0.400		
Rise time (inductive load)	t_r	I_C = 250 A, V_{CC} = 900 V, V_{GE} = ±15 V, R_{Gon} = 1 Ω	T_{vj} = 25 °C		0.070		µs
			T_{vj} = 125 °C		0.080		
			T_{vj} = 150 °C		0.080		
Turn-off delay time (inductive load)	t_{doff}	I_C = 250 A, V_{CC} = 900 V, V_{GE} = ±15 V, R_{Goff} = 1 Ω	T_{vj} = 25 °C		0.630		µs
			T_{vj} = 125 °C		0.780		
			T_{vj} = 150 °C		0.820		

(table continues...)

Table 4 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Fall time (inductive load)	t_f	I_C = 250 A, V_{CC} = 900 V, V_{GE} = ±15 V, R_{Goff} = 1 Ω	T_{vj} = 25 °C		0.150		µs
			T_{vj} = 125 °C		0.200		
			T_{vj} = 150 °C		0.210		
Turn-on energy loss per pulse	E_{on}	I_C = 250 A, V_{CC} = 900 V, L_σ = 35 nH, V_{GE} = ±15 V, R_{Gon} = 1 Ω, di/dt = 2700 A/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		77		mJ
			T_{vj} = 125 °C		105		
			T_{vj} = 150 °C		115		
Turn-off energy loss per pulse	E_{off}	I_C = 250 A, V_{CC} = 900 V, L_σ = 35 nH, V_{GE} = ±15 V, R_{Goff} = 1 Ω, dv/dt = 2600 V/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		79		mJ
			T_{vj} = 125 °C		110		
			T_{vj} = 150 °C		120		
SC data	I_{SC}	V_{GE} ≤ 15 V, V_{CC} = 1000 V, V_{CEmax}=V_{CES}-L_{sCE}*di/dt	t_P ≤ 10 µs, T_{vj}=150 °C		1300		A
Thermal resistance, junction to case	R_{thJC}	per IGBT				0.101	K/W
Thermal resistance, case to heat sink	R_{thCH}	per IGBT, λ_{grease} = 1 W/(m·K)			0.0800		K/W
Temperature under switching conditions	$T_{vj\,op}$			-40		150	°C

3 Diode, Inverter

Table 5 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Repetitive peak reverse voltage	V_{RRM}		T_{vj} = 25 °C	1700	V
Continuous DC forward current	I_F			250	A
Repetitive peak forward current	I_{FRM}	t_P = 1 ms		500	A
I^2t - value	I^2t	t_P = 10 ms, V_R = 0 V	T_{vj} = 125 °C	11000	A^2s
			T_{vj} = 150 °C	10000	

Table 6 Characteristic values

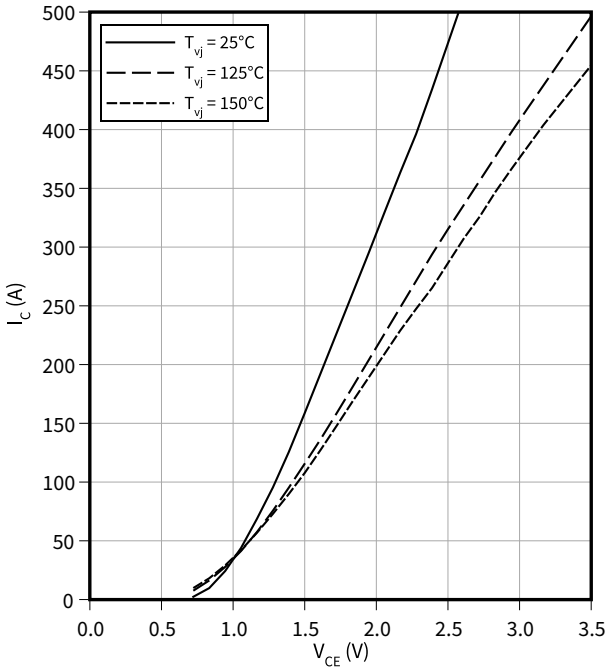
Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Forward voltage	V_F	I_F = 250 A, V_{GE} = 0 V	T_{vj} = 25 °C		1.80	2.55	V
			T_{vj} = 125 °C		1.85		
			T_{vj} = 150 °C		1.85		
Peak reverse recovery current	I_{RM}	V_{CC} = 900 V, I_F = 250 A, V_{GE} = -15 V, -di$_F$/dt = 2700 A/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		240		A
			T_{vj} = 125 °C		250		
			T_{vj} = 150 °C		255		
Recovered charge	Q_r	V_{CC} = 900 V, I_F = 250 A, V_{GE} = -15 V, -di$_F$/dt = 2700 A/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		63		µC
			T_{vj} = 125 °C		100		
			T_{vj} = 150 °C		115		
Reverse recovery energy	E_{rec}	V_{CC} = 900 V, I_F = 250 A, V_{GE} = -15 V, -di$_F$/dt = 2700 A/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		29.5		mJ
			T_{vj} = 125 °C		52.5		
			T_{vj} = 150 °C		60		
Thermal resistance, junction to case	R_{thJC}	per diode				0.215	K/W
Thermal resistance, case to heat sink	R_{thCH}	per diode, λ_{grease} = 1 W/(m·K)			0.126		K/W
Temperature under switching conditions	$T_{vj\,op}$			-40		150	°C

4 Characteristics diagrams

Output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$

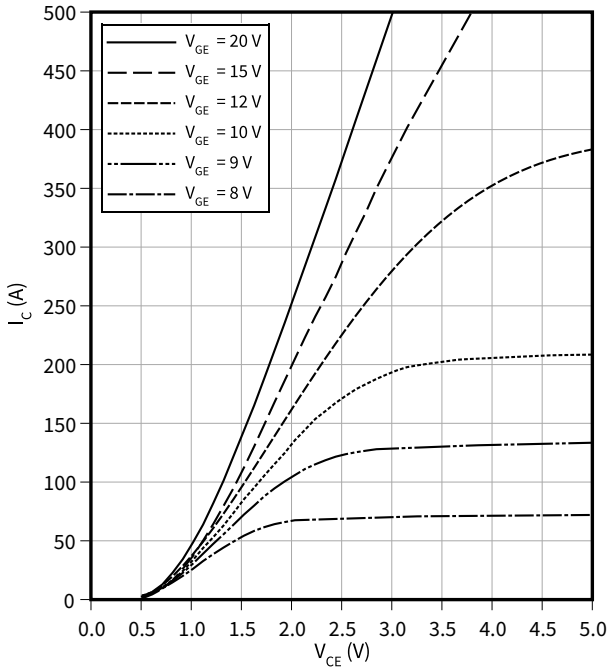
$V_{GE} = 15$ V



Output characteristic field (typical), IGBT, Inverter

$I_C = f(V_{CE})$

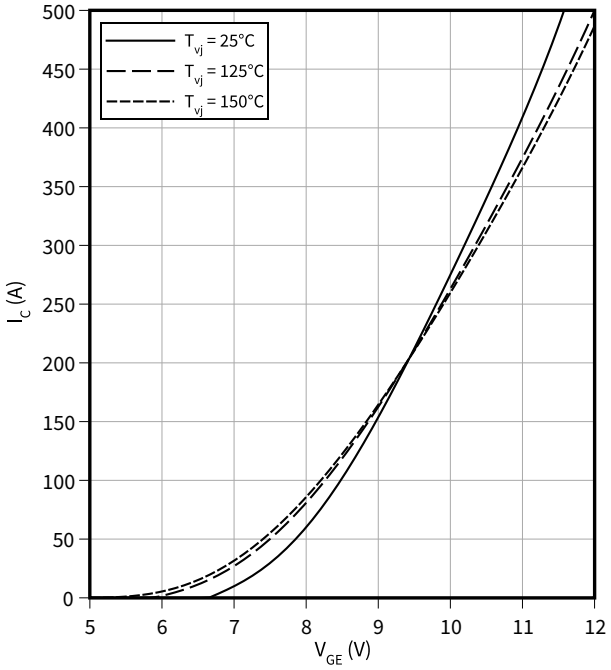
$T_{vj} = 150$ °C



Transfer characteristic (typical), IGBT, Inverter

$I_C = f(V_{GE})$

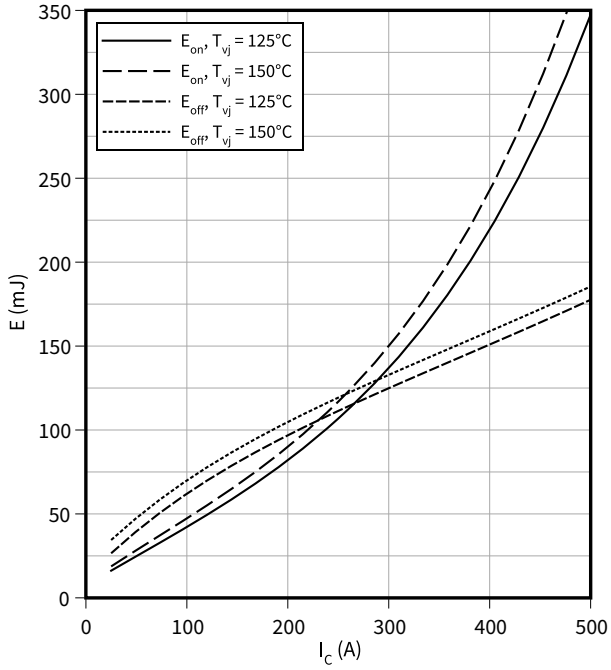
$V_{CE} = 20$ V



Switching losses (typical), IGBT, Inverter

$E = f(I_C)$

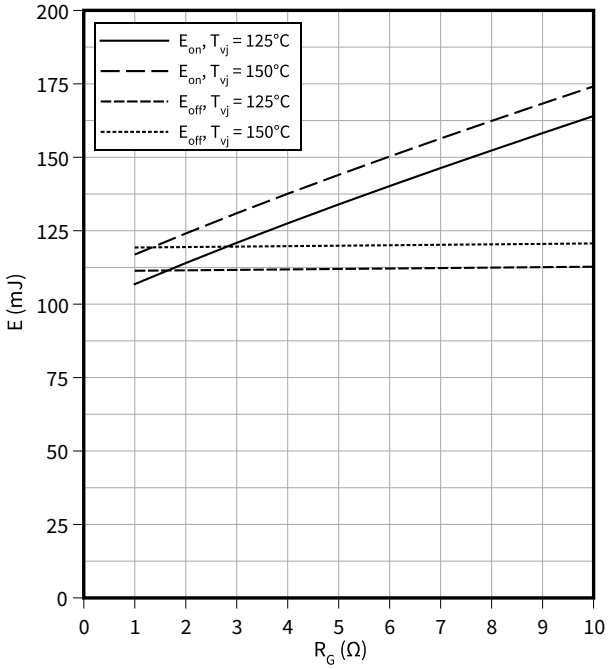
$V_{CC} = 900$ V, $R_{Goff} = 1\ \Omega$, $R_{Gon} = 1\ \Omega$, $V_{GE} = \pm 15$ V



Switching losses (typical), IGBT, Inverter

$E = f(R_G)$

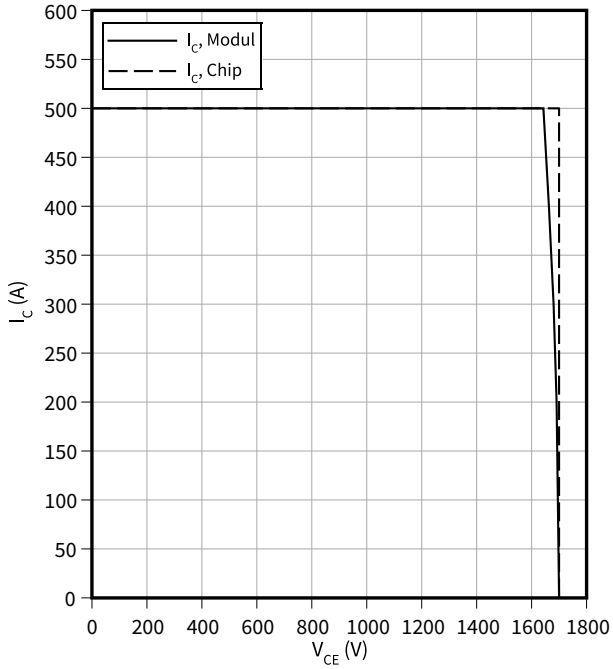
$V_{GE} = \pm 15$ V, $I_C = 250$ A, $V_{CC} = 900$ V



Reverse bias safe operating area (RBSOA), IGBT, Inverter

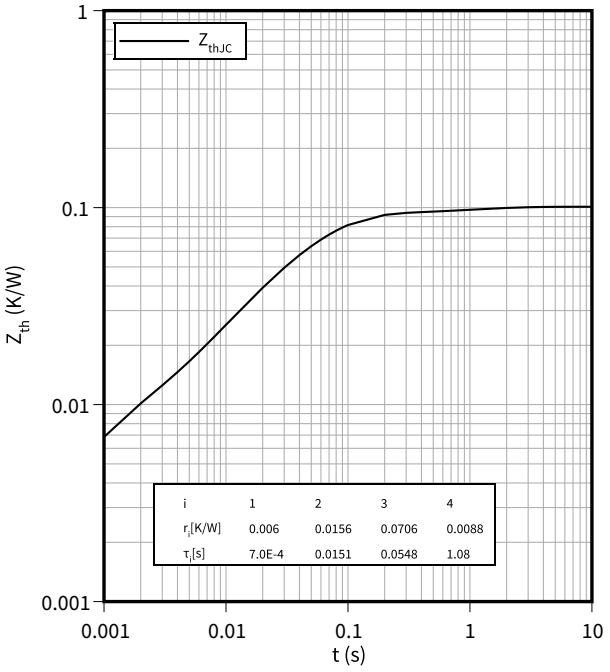
$I_C = f(V_{CE})$

$R_{Goff} = 1\ \Omega$, $V_{GE} = \pm 15$ V, $T_{vj} = 150$ °C



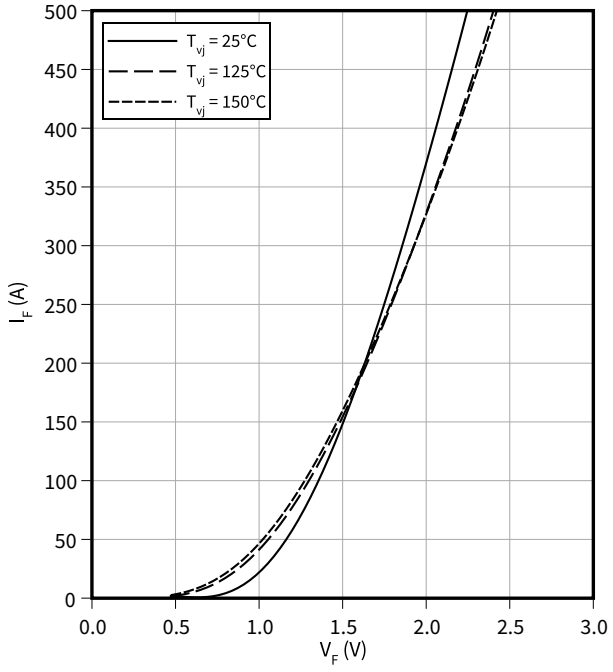
Transient thermal impedance, IGBT, Inverter

$Z_{th} = f(t)$



Forward characteristic (typical), Diode, Inverter

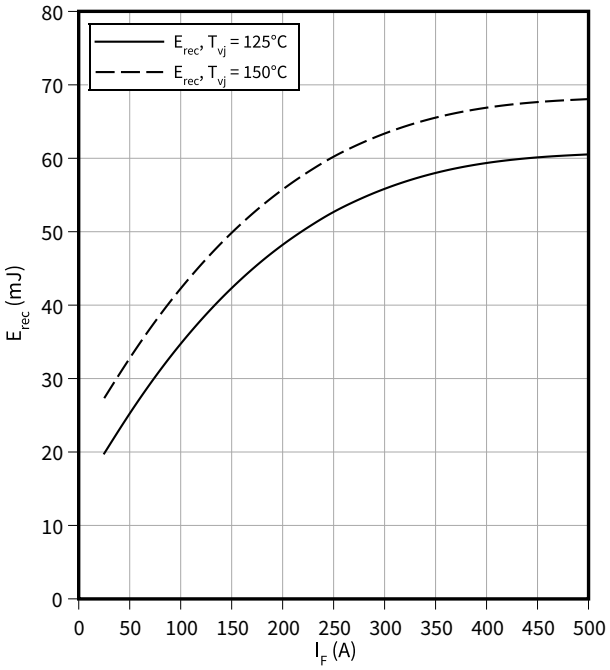
$I_F = f(V_F)$



Switching losses (typical), Diode, Inverter

$E_{rec} = f(I_F)$

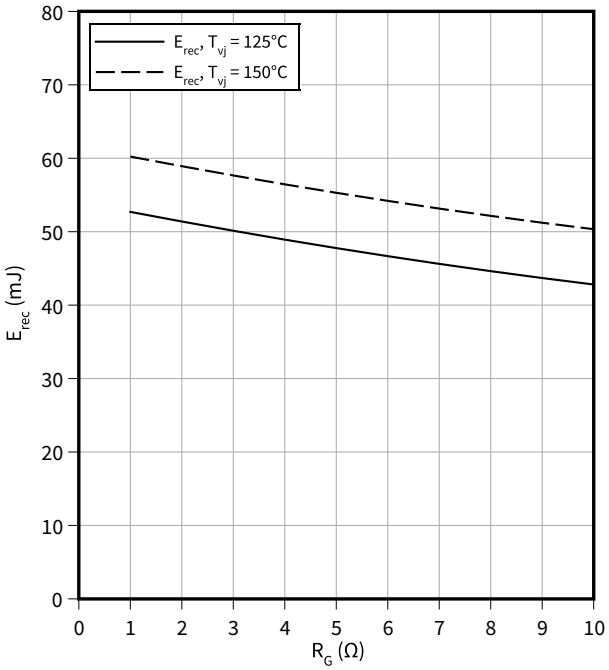
$R_{Gon} = 1\ \Omega$, $V_{CC} = 900$ V



Switching losses (typical), Diode, Inverter

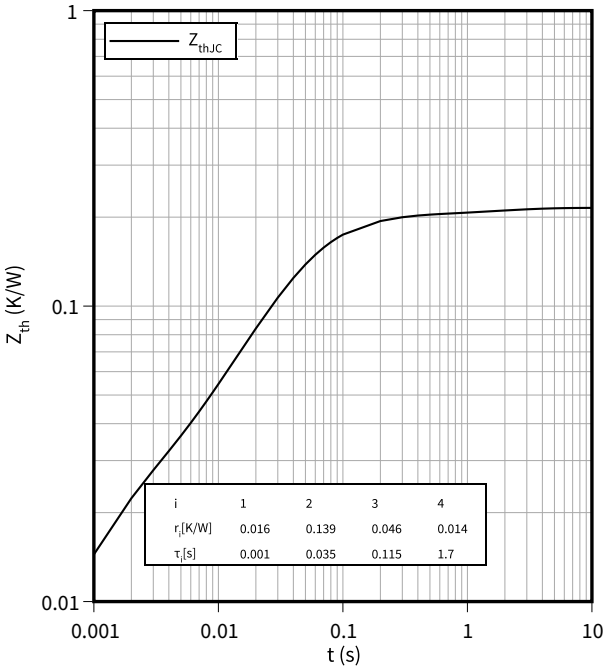
$E_{rec} = f(R_G)$

$I_F = 250$ A, $V_{CC} = 900$ V



Transient thermal impedance, Diode, Inverter

$Z_{th} = f(t)$



5 Circuit diagram

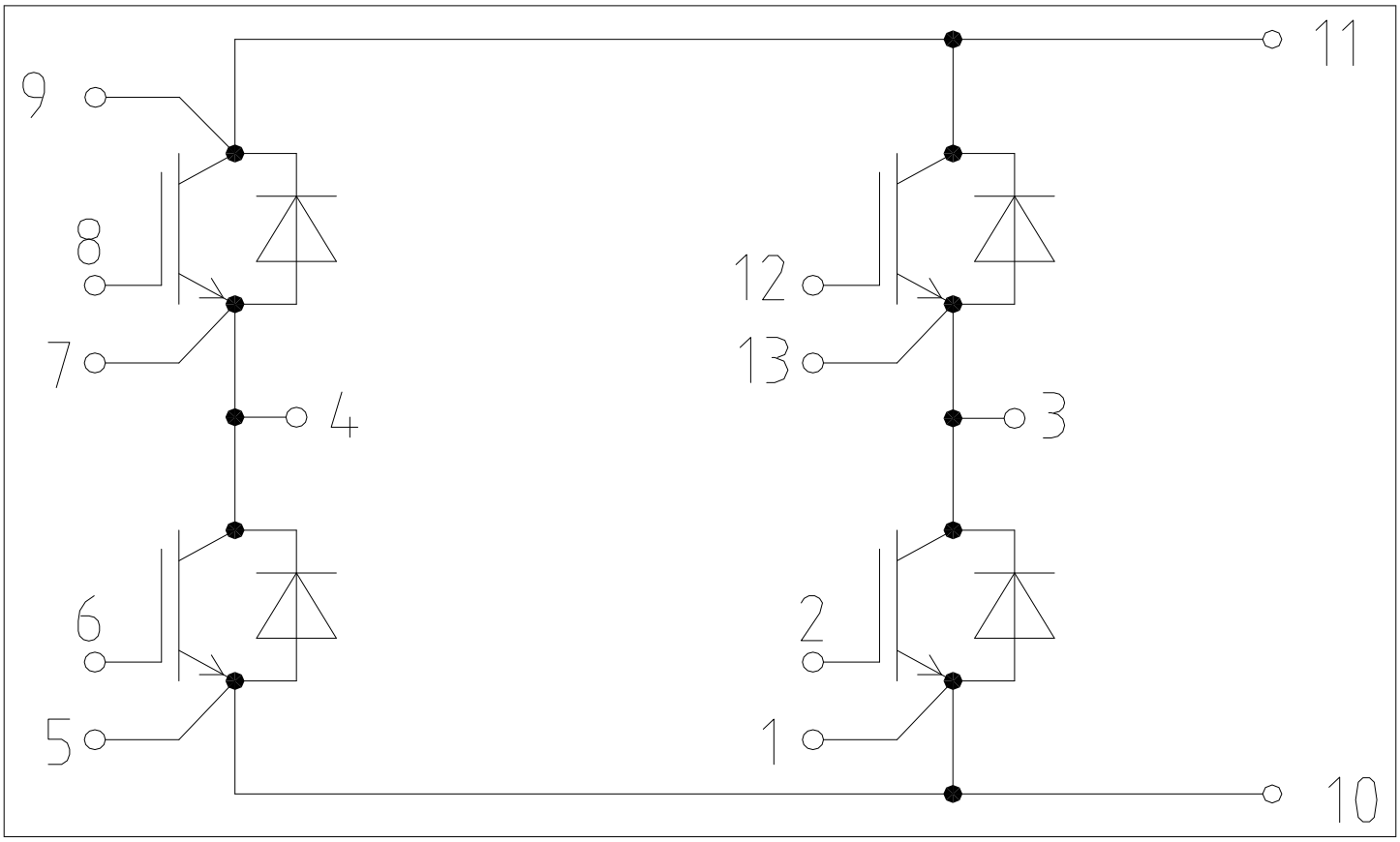


Figure 1

6 Package outlines

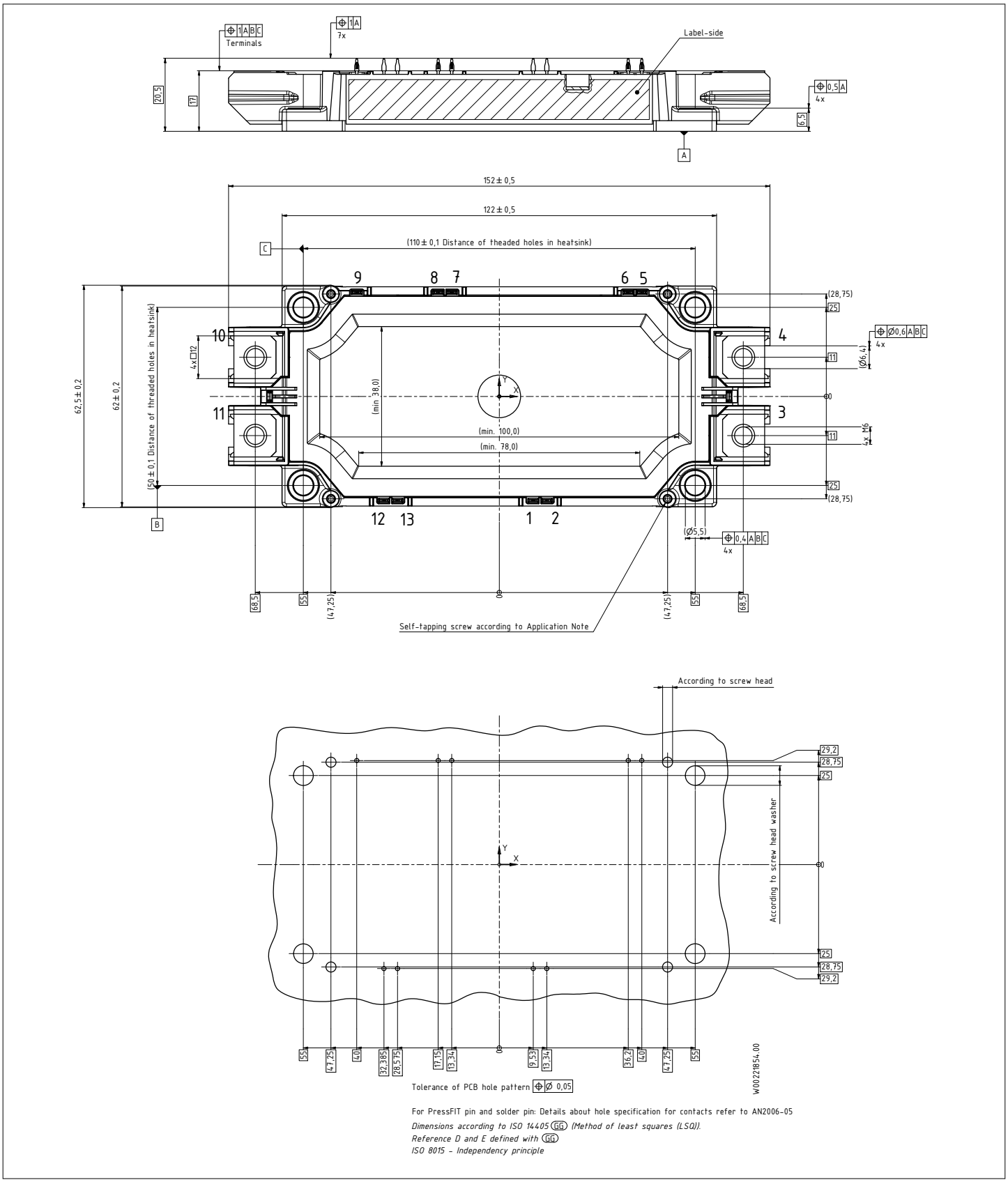


Figure 2

7 Module label code

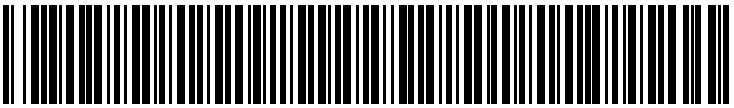
Module label code			
Code format	Data Matrix		Barcode Code128
Encoding	ASCII text		Code Set A
Symbol size	16x16		23 digits
Standard	IEC24720 and IEC16022		IEC8859-1
Code content	*Content* Module serial number Module material number Production order number Date code (production year) Date code (production week)	*Digit* 1 – 5 6 - 11 12 - 19 20 – 21 22 – 23	*Example* 71549 142846 55054991 15 30
Example	 7154914284655054991530	 7154914284655054991530	

Figure 3

Revision history

Document revision	Date of release	Description of changes
V1.0	2012-08-22	Target datasheet
V1.1	2012-12-19	Target datasheet
V1.2	2013-01-07	Target datasheet
V1.3	2014-07-22	Target datasheet
V1.4	2014-12-01	Target datasheet
V1.5	2015-12-02	Target datasheet
V3.0	2016-04-18	Final datasheet
V3.1	2017-09-07	Final datasheet
V3.2	2017-09-18	Final datasheet
n/a	2020-09-01	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
1.10	2024-03-18	Final datasheet

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